

<b>INFORMATION DISCLOSURE STATEMENT BY APPLICANT</b>  (use as many sheets as necessary)		<b>Complete if Known</b>	
		Application Number	10/536,463
		Filing Date	March 13, 2006
		First Named Inventor	Rama Venkatasubramanian et al.
		Group Art Unit	2811
		Examiner Name	Mowla, Golam
Sheet	Page 1 of 2	Attorney Docket Number	9510-11

U.S. PATENTS AND PATENT PUBLICATIONS					
Examiner Initials*	Cite No.	U.S. Patent Document		Name of Patentee or Applicant of Cited Document	Date of Publication of Cited Document MM-DD-YYYY
		Number	Kind Code (if known)		
	1.	US 2003/0209014		Chang et al.	11/13/2003
	2.	US 2002/0046762		Rossi	04/25/2002
	3.	US 2003/0099279		Venkatasubramanian	5/29/2003
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Examiner Initials*	Cite No.	Foreign Patent Document			Name of Patentee or Applicant of Cited Document	Date of Publication of Cited Document MM-DD-YYYY	Translation
		Office	Number	Kind Code (if known)			
	19.	WO	2005/074463	A2	Nextreme Thermal Solutions	8/18/2005	Yes
	20.	WO	2004/049463	A1	Venkatasubramanian et al.	06/10/2004	Yes
	21.	JP	2002-232028	A	Onoe et al.	08/16/2002	Abstract
	22.	JP	2002-111080	A	Okada	04/12/2002	Abstract

OTHER NON PATENT LITERATURE DOCUMENTS					T
Examiner Initials*	Cite No.	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city and/or country where published			
	23.	Fontanazza "A Cooler Way to Stop Seizures " <i>Medical Device &amp; Diagnostic Industry Magazine</i> pages 1-2 (2005)			
	24.	Ettenberg et al. "A New n-type and Improved p-type Pseudo-ternary (Bi <sub>2</sub> Te <sub>3</sub> )(Sb <sub>2</sub> Se <sub>3</sub> ) Alloy for Peltier Cooling" 15 <sup>th</sup> International Conference on Thermoelectrics, IEEE Catalog No. 96TH8169 pages 52-56 (1996)			
	25.	Kloeser "High-Performance flip chip packages with copper pillar bumping " <i>Global SMT &amp; Packaging</i> pages 28-31 (May 2006), www.globalsmt.net			

Examiner Signature		Date Considered	
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\*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

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	26.	Press Release, Marlow Industries "New, Low-Profile Planar TEC Cools Detectors, Drives Cost Down" April 29, 2008, Planar TEC, <a href="http://www.marlow.com/AboutMarlow/PressReleases/press_release_Apr_29_2008.htm">http://www.marlow.com/AboutMarlow/PressReleases/press_release_Apr_29_2008.htm</a>	
	27.	Press Release, Marlow Industries "New, Low-Profile Planar TEC Cools Detectors, Drives Cost Down" April 29, 2008, ThomasNet Industrial Newsroom, <a href="http://news.thomasnet.com/printreadycn.html?prid=816927">http://news.thomasnet.com/printreadycn.html?prid=816927</a>	
	28.	Rothman "Pathophysiology and therapy of epilepsy" Website of Professor Steven Rothman, M.D. of Washington University in St. Louis: <a href="http://neuroscience.wustl.edu/research/faculty.php?id=81">http://neuroscience.wustl.edu/research/faculty.php?id=81</a>	
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	30.	Venkatasubramanian et al. "Phonon-Blocking Electron-Transmitting Structures" 18 <sup>th</sup> International Conference on Thermoelectrics (1999), pages 100-103	

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